



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: IIJIMA, et al.

Serial No.: 09/466,895

Group Art Unit: 3729

Filed: December 20, 1999

Examiner: Rick Kiltae Chang

P.T.O. Confirmation No.: 1709

For: A METHOD FOR FABRICATING A WIRING SUBSTRATE BY  
ELECTROPLATING A WIRING FILM ON A METAL BASE (As Amended)

AMENDMENT UNDER 37 CFR §1.111

Commissioner for Patents  
Washington, D.C. 20231

November 27, 2002

Sir:

In response to the Office Action dated August 29, 2002, please amend the above-identified application as follows:

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DEC - 2 2002

TECHNOLOGY CENTER R3700

IN THE TITLE:

Please amend the title of the invention, in its entirety, so as to read as follows:

A METHOD FOR FABRICATING A WIRING SUBSTRATE BY ELECTROPLATING A  
WIRING FILM ON A METAL BASE

IN THE ABSTRACT:

Please delete the current Abstract and replace therewith the attached substitute

Abstract.

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